

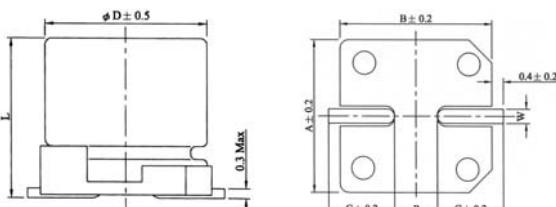
## Features

- 4 ~ 6.3  $\phi$ , 85°C, 2,000 hours assured
  - Vertical chip type miniaturized for 5.5mm, high capacitors
  - Low Leakage Current Lead free reflow soldering is available.
  - Designed for surface mounting on high density PC board.
  - RoHS Compliance



## SPECIFICATIONS

## DIAGRAM OF DIMENSIONS



LEAD SPACING AND DIAMETER						Unit: mm
$\phi D$	L	A	B	C	W	P $\pm$ 0.2
4	5.3 $\pm$ 0.2	4.3	4.3	2.0	0.5 to 0.8	1.0
5	5.3 $\pm$ 0.2	5.3	5.3	2.3	0.5 to 0.8	1.5
6.3	5.3 $\pm$ 0.2	6.6	6.6	2.7	0.5 to 0.8	2.0

Dimension:  $\phi D \times L$ (mm)

Ripple Current: mA/rms at 120 Hz, 85°C

## DIMENSION & PERMISSIBLE RIPPLE CURRENT